



Material Content Data Sheet



Halogen-Free

Sales Product Name	IPP65R150CFDA	Issued	05. May 2021
MA#	MA001212258		
Package	PG-TO220-3-1	Weight*	2040.59 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	11.566	0.57	0.57	5668	5668
leadframe	inorganic material	phosphorus	7723-14-0	0.245	0.01		120	
	non noble metal	iron	7439-89-6	0.816	0.04		400	
	non noble metal	copper	7440-50-8	815.335	39.95	40.00	399557	400077
wire	non noble metal	aluminium	7429-90-5	3.156	0.15	0.15	1547	1547
encapsulation	inorganic material	zinc oxide	1314-13-2	5.901	0.29		2892	
	miscellaneous	miscellaneous	-	23.604	1.16		11567	
	plastics	epoxy resin	-	88.515	4.34		43377	
	inorganic material	silicon dioxide	60676-86-0	472.079	23.13	28.92	231345	289181
lead finish	non noble metal	tin	7440-31-5	21.462	1.05	1.05	10518	10518
plating	inorganic material	phosphorus	7723-14-0	0.001			1	
	non noble metal	nickel	7440-02-0	0.244	0.01	0.01	120	121
solder	non noble metal	tin	7440-31-5	0.149	0.01		73	
	noble metal	silver	7440-22-4	0.186	0.01		91	
	non noble metal	lead	7439-92-1	7.098	0.35	0.37	3478	3642
heatspreader	inorganic material	phosphorus	7723-14-0	0.177	0.01		87	
	non noble metal	iron	7439-89-6	0.590	0.03		289	
	non noble metal	copper	7440-50-8	589.466	28.89	28.93	288870	289246
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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